

7929237 0046274 434 ■SGTH



**STP5N60**  
**STP5N60FI**

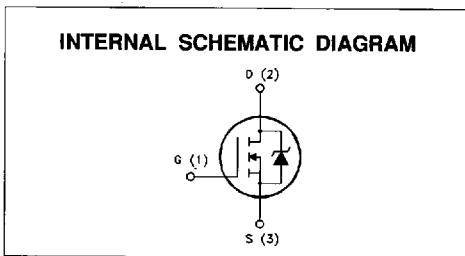
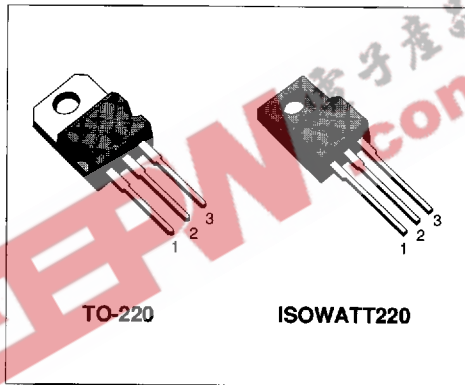
**N - CHANNEL ENHANCEMENT MODE  
POWER MOS TRANSISTOR**

| TYPE      | V <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|-----------|------------------|---------------------|----------------|
| STP5N60   | 600 V            | < 1.6 Ω             | 5.6 A          |
| STP5N60FI | 600 V            | < 1.6 Ω             | 3.2 A          |

- TYPICAL R<sub>DS(on)</sub> = 1.33 Ω
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C
- APPLICATION ORIENTED CHARACTERIZATION

**APPLICATIONS**

- HIGH CURRENT, HIGH SPEED SWITCHING
- SWITCH MODE POWER SUPPLIES (SMPS)
- CHOPPER REGULATORS, CONVERTERS, MOTOR CONTROL, LIGHTING FOR INDUSTRIAL AND CONSUMER ENVIRONMENT



**ABSOLUTE MAXIMUM RATINGS**

| Symbol              | Parameter   | Value      |           | Unit |
|---------------------|---|------------|-----------|------|
|                     |   | STP5N60    | STP5N60FI |      |
| V <sub>DS</sub>     | Drain-source Voltage (V <sub>GS</sub> = 0)            | 600        |           | V    |
| V <sub>DGR</sub>    | Drain- gate Voltage (R <sub>GS</sub> = 20 kΩ)         | 600        |           | V    |
| V <sub>GS</sub>     | Gate-source Voltage                                   | ± 20       |           | V    |
| I <sub>D</sub>      | Drain Current (continuous) at T <sub>c</sub> = 25 °C  | 5.6        | 3.2       | A    |
| I <sub>D</sub>      | Drain Current (continuous) at T <sub>c</sub> = 100 °C | 3.5        | 2         | A    |
| I <sub>DM</sub> (*) | Drain Current (pulsed)                                | 20         | 20        | A    |
| P <sub>tot</sub>    | Total Dissipation at T <sub>c</sub> = 25 °C           | 100        | 40        | W    |
|                     | Derating Factor                                       | 1          | 0.32      | W/°C |
| V <sub>ISO</sub>    | Insulation Withstand Voltage (DC)                     | —          | 2000      | V    |
| T <sub>stg</sub>    | Storage Temperature                                   | -65 to 150 |           | °C   |
| T <sub>j</sub>      | Max. Operating Junction Temperature                   | 150        |           | °C   |

(\*) Pulse width limited by safe operating area

STP5N60/FI

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## THERMAL DATA

|                |  |     | TO-220 | ISOWATT220 |      |
|----------------|--|-----|--------|------------|------|
| $R_{thj-case}$ | Thermal Resistance Junction-case               | Max | 1      | 3.12       | °C/W |
| $R_{thj-amb}$  | Thermal Resistance Junction-ambient            | Max |        | 62.5       | °C/W |
| $R_{thc-sink}$ | Thermal Resistance Case-sink                   | Typ |        | 0.5        | °C/W |
| $T_l$          | Maximum Lead Temperature For Soldering Purpose |     |        | 300        | °C   |

## AVALANCHE CHARACTERISTICS

| Symbol   | Parameter  | Max. Value | Unit |
|----------|--|------------|------|
| $I_{AR}$ | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by $T_j$ max, $\delta < 1\%$ )                              | 5.6        | A    |
| $E_{AS}$ | Single Pulse Avalanche Energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DS} = 50\text{ V}$ )                     | 350        | mJ   |
| $E_{AR}$ | Repetitive Avalanche Energy (pulse width limited by $T_j$ max, $\delta < 1\%$ )  | 15         | mJ   |
| $I_{AR}$ | Avalanche Current, Repetitive or Not-Repetitive ( $T_c = 100^\circ\text{C}$ , pulse width limited by $T_j$ max, $\delta < 1\%$ ) | 3.5        | A    |

ELECTRICAL CHARACTERISTICS ( $T_{case} = 25^\circ\text{C}$  unless otherwise specified)

OFF

| Symbol        | Parameter  | Test Conditions   | Min. | Typ. | Max.        | Unit                           |
|---------------|--|---|------|------|-------------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source Breakdown Voltage                   | $I_D = 250\ \mu\text{A}$ $V_{GS} = 0$   | 600  |      |             | V                              |
| $I_{DSS}$     | Zero Gate Voltage Drain Current ( $V_{GS} = 0$ ) | $V_{DS} = \text{Max Rating}$<br>$V_{DS} = \text{Max Rating} \times 0.8$ $T_c = 125^\circ\text{C}$ |      |      | 250<br>1000 | $\mu\text{A}$<br>$\mu\text{A}$ |
| $I_{GSS}$     | Gate-body Leakage Current ( $V_{DS} = 0$ )       | $V_{GS} = \pm 20\text{ V}$  |      |      | $\pm 100$   | nA                             |

ON (\*)

| Symbol       | Parameter                         | Test Conditions  | Min. | Typ. | Max.     | Unit                 |
|--------------|-----------------------------------|--|------|------|----------|----------------------|
| $V_{GS(th)}$ | Gate Threshold Voltage            | $V_{DS} = V_{GS}$ $I_D = 250\ \mu\text{A}$   | 2    | 3    | 4        | V                    |
| $R_{DS(on)}$ | Static Drain-source On Resistance | $V_{GS} = 10\text{ V}$ $I_D = 2.5\text{ A}$<br>$V_{GS} = 10\text{ V}$ $I_D = 2.5\text{ A}$ $T_c = 100^\circ\text{C}$ |      | 1.33 | 1.5<br>3 | $\Omega$<br>$\Omega$ |
| $I_{D(on)}$  | On State Drain Current            | $V_{DS} > I_{D(on)} \times R_{DS(on)max}$<br>$V_{GS} = 10\text{ V}$  | 5.6  |      |          | A                    |

DYNAMIC

| Symbol       | Parameter                    | Test Conditions  | Min. | Typ. | Max. | Unit |
|--------------|------------------------------|--|------|------|------|------|
| $g_{fs} (*)$ | Forward Transconductance     | $V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_D = 2.5\text{ A}$ | 1.5  | 3.4  |      | S    |
| $C_{iss}$    | Input Capacitance            | $V_{DS} = 25\text{ V}$ $f = 1\text{ MHz}$ $V_{GS} = 0$         |      | 720  | 1000 | pF   |
| $C_{oss}$    | Output Capacitance           |  |      | 120  | 170  | pF   |
| $C_{rss}$    | Reverse Transfer Capacitance |  |      | 50   | 70   | pF   |

**ELECTRICAL CHARACTERISTICS** (continued)  
SWITCHING ON

| Symbol         | Parameter             | Test Conditions   | Min. | Typ. | Max. | Unit       |
|----------------|-----------------------|---|------|------|------|------------|
| $t_{d(on)}$    | Turn-on Time          | $V_{DD} = 300\text{ V}$ $I_D = 2.5\text{ A}$  |      | 55   | 75   | ns         |
| $t_r$          | Rise Time             | $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see test circuit, figure 3)   |      | 150  | 200  | ns         |
| $(di/dt)_{on}$ | Turn-on Current Slope | $V_{DD} = 480\text{ V}$ $I_D = 5\text{ A}$<br>$R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see test circuit, figure 5) |      | 115  |      | A/ $\mu$ s |
| $Q_g$          | Total Gate Charge     | $V_{DD} = 480\text{ V}$ $I_D = 5\text{ A}$ $V_{GS} = 10\text{ V}$   |      | 46   | 65   | nC         |
| $Q_{gs}$       | Gate-Source Charge    |   |      | 8    |      | nC         |
| $Q_{gd}$       | Gate-Drain Charge     |   |      | 25   |      | nC         |

SWITCHING OFF

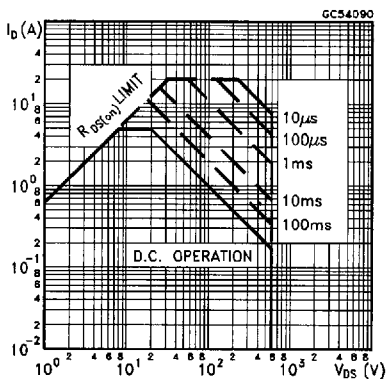
| Symbol         | Parameter             | Test Conditions   | Min. | Typ. | Max. | Unit |
|----------------|-----------------------|---|------|------|------|------|
| $t_r(V_{off})$ | Off-voltage Rise Time | $V_{DD} = 480\text{ V}$ $I_D = 5\text{ A}$                                |      | 80   | 105  | ns   |
| $t_f$          | Fall Time             | $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see test circuit, figure 5) |      | 25   | 35   | ns   |
| $t_c$          | Cross-over Time       |   |      | 120  | 160  | ns   |

SOURCE DRAIN DIODE

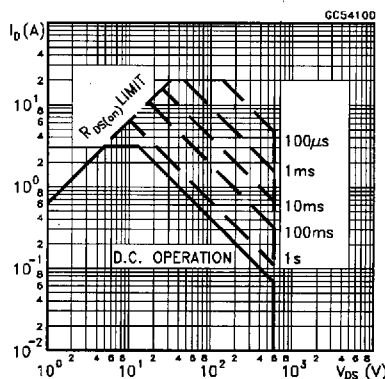
| Symbol             | Parameter                     | Test Conditions   | Min. | Typ. | Max. | Unit          |
|--------------------|-------------------------------|---|------|------|------|---------------|
| $I_{SD}$           | Source-drain Current          |   |      |      | 5.6  | A             |
| $I_{SDM}(\bullet)$ | Source-drain Current (pulsed) |   |      |      | 20   | A             |
| $V_{SD}(\ast)$     | Forward On Voltage            | $I_{SD} = 5.9\text{ A}$ $V_{GS} = 0$  |      |      | 2    | V             |
| $t_{rr}$           | Reverse Recovery Time         | $I_{SD} = 6\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 100\text{ V}$ $T_j = 150\text{ }^\circ\text{C}$<br>(see test circuit, figure 5) |      | 525  |      | ns            |
| $Q_{rr}$           | Reverse Recovery Charge       |   |      | 5.8  |      | $\mu\text{C}$ |
| $I_{RRM}$          | Reverse Recovery Current      |   |      | 22   |      | A             |

(\*) Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5 %  
( $\bullet$ ) Pulse width limited by safe operating area

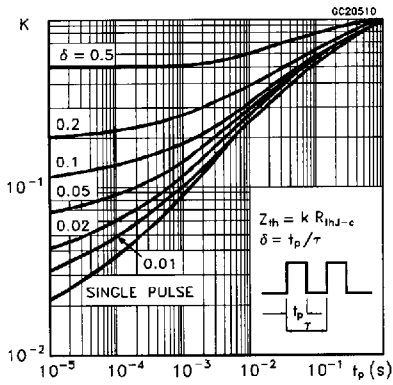
Safe Operating Areas For TO-220



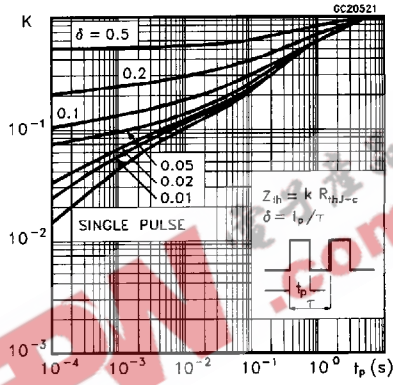
Safe Operating Areas For ISOWATT220



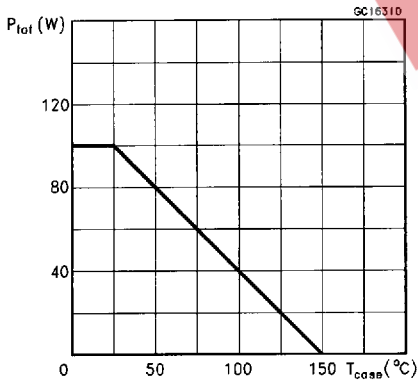
Thermal Impedance For TO-220



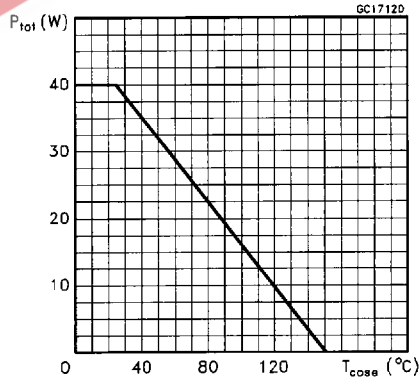
Thermal Impedance For ISOWATT220



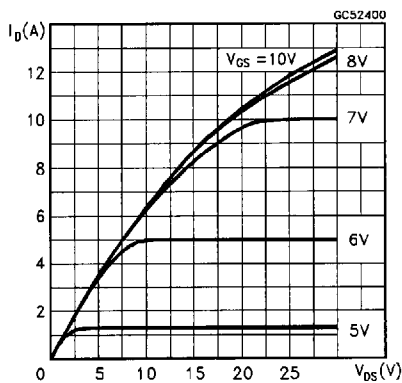
Derating Curve For TO-220



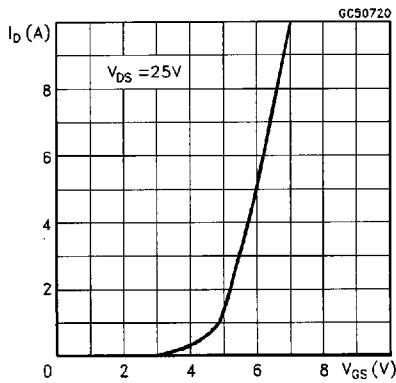
Derating Curve For ISOWATT220



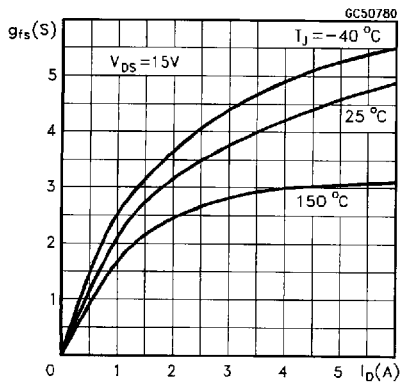
Output Characteristics



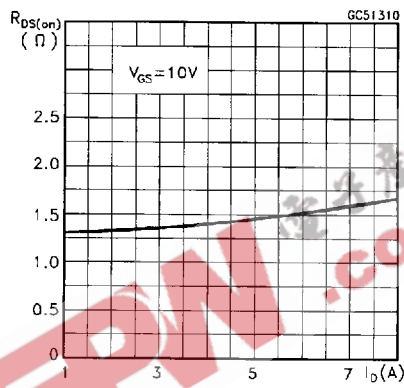
Transfer Characteristics



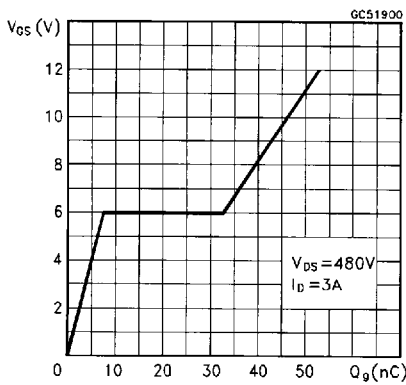
Transconductance



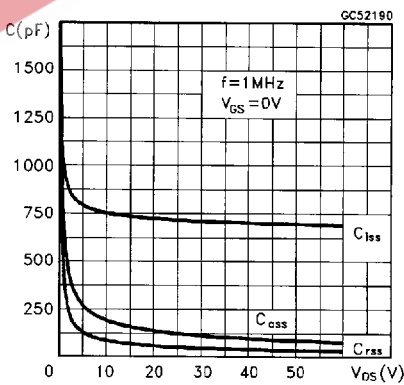
Static Drain-source On Resistance



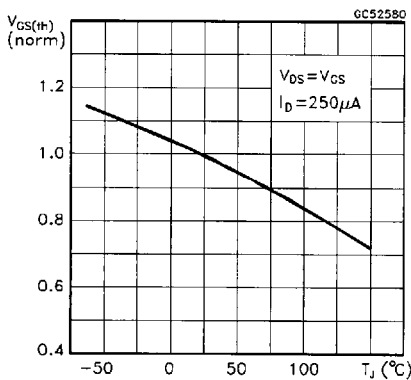
Gate Charge vs Gate-source Voltage



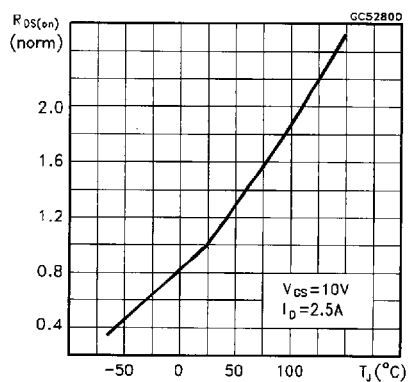
Capacitance Variations



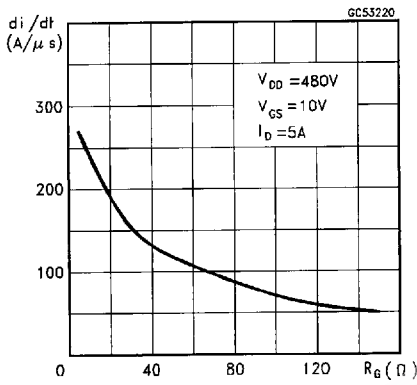
Normalized Gate Threshold Voltage vs Temperature



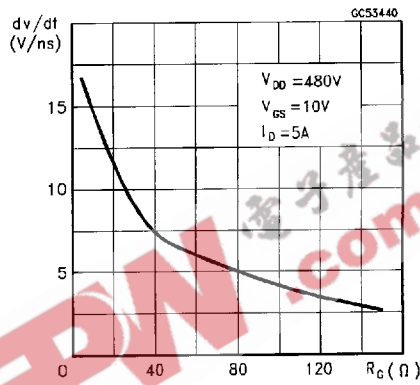
Normalized On Resistance vs Temperature



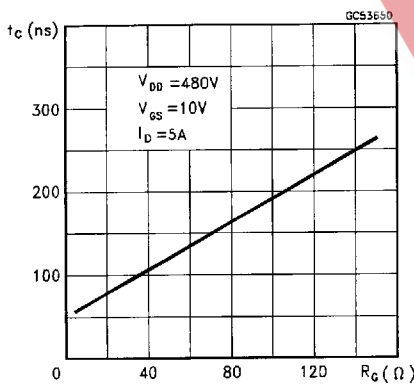
Turn-on Current Slope



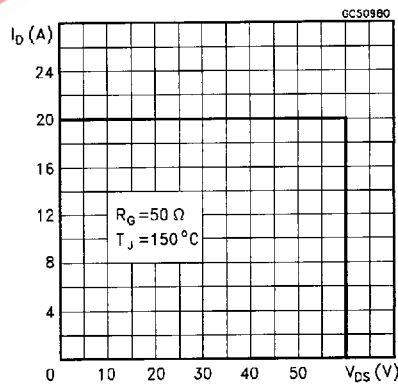
Turn-off Drain-source Voltage Slope



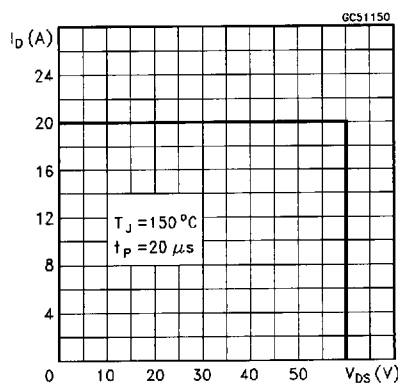
Cross-over Time



Switching Safe Operating Area



Accidental Overload Area



Source-drain Diode Forward Characteristics

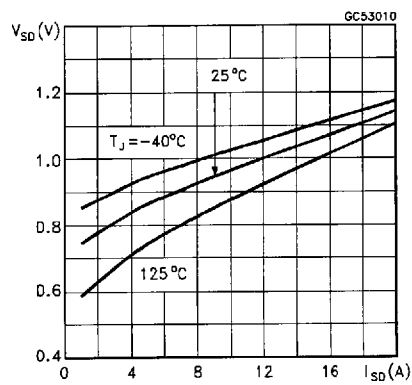


Fig. 1: Unclamped Inductive Load Test Circuits

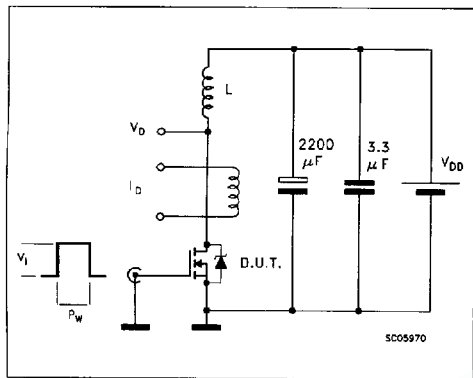


Fig. 2: Unclamped Inductive Waveforms

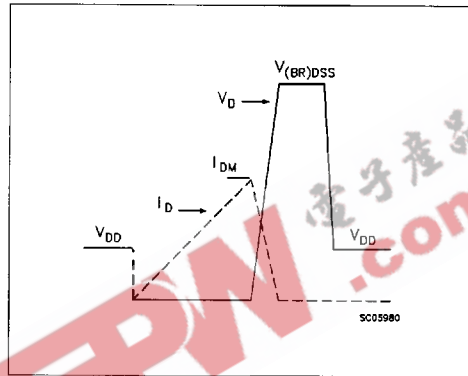


Fig. 3: Switching Times Test Circuits For Resistive Load

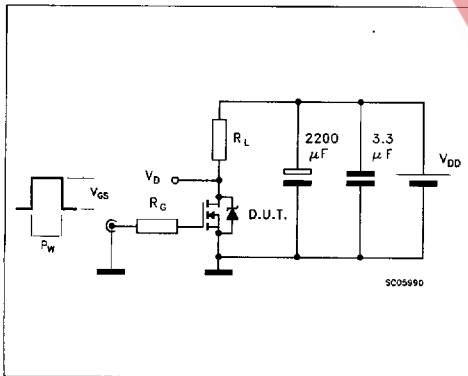


Fig. 4: Gate Charge Test Circuit

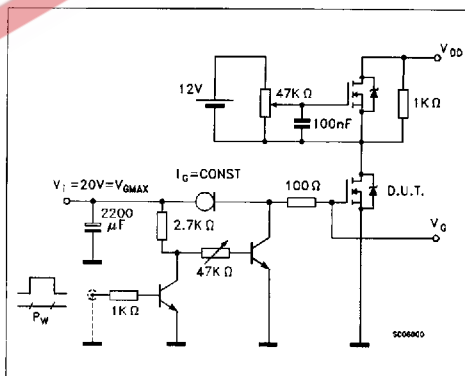


Fig. 5: Test Circuit For Inductive Load Switching And Diode Reverse Recovery Time

